

Atty. Dkt. No. QUANT1190-3 (028248-1010)  
LDQ-1190-CIP3

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Dershem et al.

Title: THERMOSETTING RESIN  
COMPOSITIONS CONTAINING  
MALEIMIDE AND/OR VINYL  
COMPOUNDS

Appl. No.: 10/084,389

Filing Date: 02/25/2002

Examiner: Not Yet Assigned

Art Unit: 1712

**CERTIFICATE OF FACSIMILE TRANSMISSION**  
I hereby certify that this paper is being facsimile transmitted to the United States Patent and Trademark Office, Washington, D.C. on the date below.

Stephen E. Reiter  
(Printed Name)

[Signature]  
(Signature)

August 1, 2002  
(Date of Deposit)

**FAX RECEIVED**

AUG 1 2002

**SUPPLEMENTAL PRELIMINARY AMENDMENT GROUP 1700**

Commissioner for Patents  
Washington, D.C. 20231

**OFFICIAL**

Sir:

Preliminary to examination on the merits, kindly amend the application as follows:

**IN THE SPECIFICATION:**

Kindly delete page 1, lines 1-5 of the Specification and insert therefor after the

Title:

**-- RELATED APPLICATIONS**

This application is a continuation of U.S. Patent Application No. 09/580,026, filed May 26, 2000, which is a continuation-in-part of U.S. Patent Application No. 09/107,897, filed June 29, 1998, now U.S. Patent No. 6,187,886, which itself is a continuation-in-part of U.S. Patent Application No. 08/711,982, filed September 10, 1996 (now U.S. Patent No. 5,789,757); this application also claims the benefit of an earlier